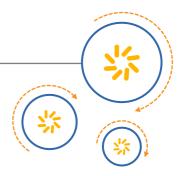


RF360 Europe GmbH
A Qualcomm – TDK Joint Venture



SAW components

SAW RF filter

Digital radio

Series/type: B1669

Ordering code: B39232B1669U410

Date: July 02, 2017

Version: 2.6

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1 Application

- Low-loss RF filter for digital radio
- Low amplitude ripple
- Usable pass band 25.0 MHz

2 Features

- Package size 3.0±0.1 mm × 3.0±0.1 mm
- Package height 1.1±0.125 mm
- Package code DCC6C
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Lead free soldering compatible with J-STD20C
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)
- AEC-Q200 qualified component family (Grade 1: -40 °C to +125 °C)

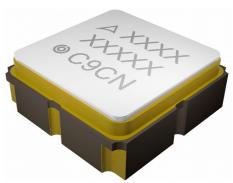
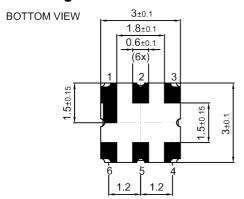


Figure 1: Picture of component with example of product marking.

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3 Package

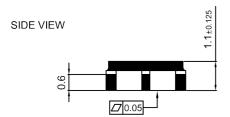


4 Pin configuration

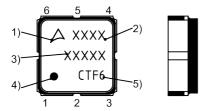
■ 2 Input

■ 5 Output

■ 1, 3, 4, 6 Ground



TOP VIEW SIDE VIEW



- 1) Company logo
- 2) Device designation
- 3) Last five digits of the lot number
- 4) Marking for pad number 1
- 5) Example of production location and date code

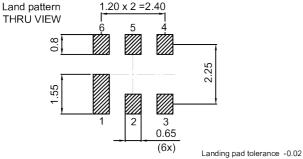


Figure 2: Drawing of package. See Sec. Package information (p. 17).



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5 Matching circuit

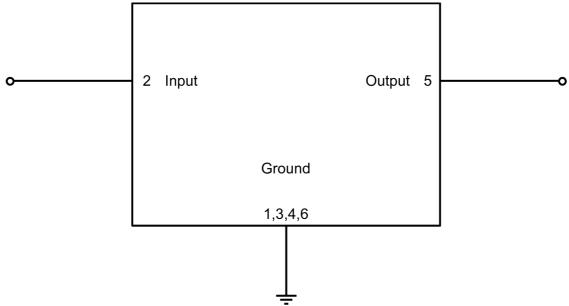


Figure 3: Schematic of matching circuit. No external matching components required.



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Characteristics

 $T_{
m SPEC} \ Z_{
m IN} \ Z_{
m OUT}$ Temperature range for specification = -45 °C ... +105 °C Input terminating impedance = 50 Ω

Output terminating impedance = 50 Ω

Characteristics				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	_	2332.5	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	2320 2345	MHz		_	2.4	2.8	dB
Amplitude ripple (p-p)			Δα				
	2320 2345	MHz		_	0.6	1.0	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	2320 2345	MHz		_	1.6	2.0	
@ output port	2320 2345	MHz		_	1.6	2.0	
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	50 2120	MHz		40	47	_	dB
	2560 3000	MHz		36	40	_	dB
	3000 3500	MHz		33	37	_	dB
	3500 4000	MHz		30	34	_	dB
	4000 5000	MHz		20	26	_	dB
Group delay ripple			$\Delta \tau_{\text{var}}$				
	2320 2345	MHz		_	5.0	15	ns



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7 Maximum ratings

Operable temperature	T _{OP} = −45 °C +125 °C	
Storage temperature	T _{STG} ¹⁾ = −45 °C +125 °C	
DC voltage	V _{DC} = 6.0 V	
ESD voltage	V _{ESD} ²⁾ = 50 V	Machine model.
Input power	P _{IN}	
@ input port: 700 2170 MHz	20 dBm	
@ input port: 2320 2345 MHz	10 dBm	
@ input port: 2500 3000 MHz	20 dBm	

Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.

²⁾ According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.



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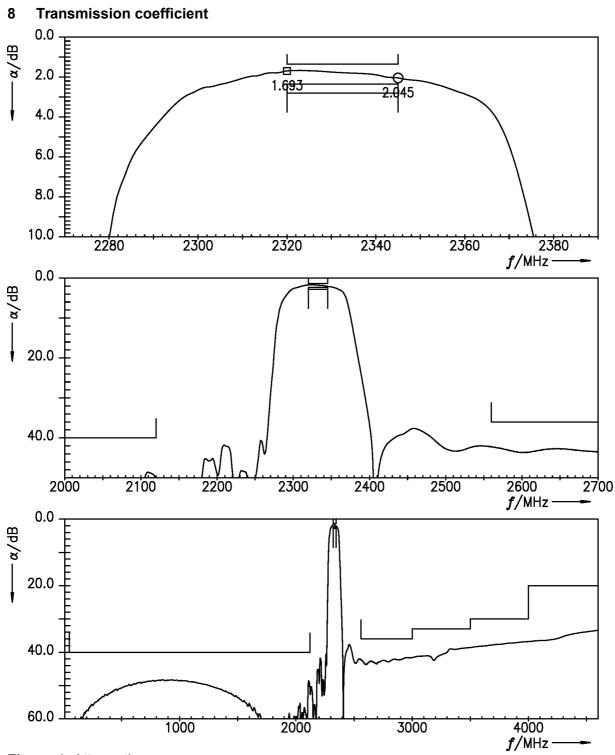


Figure 4: Attenuation.



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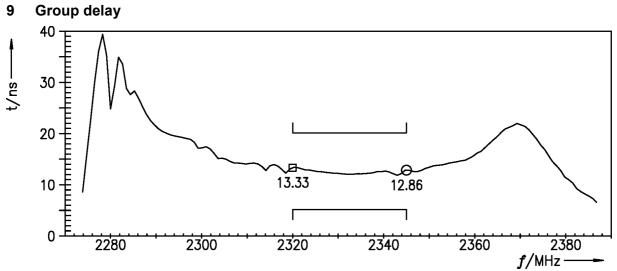


Figure 5: Group delay ripple.

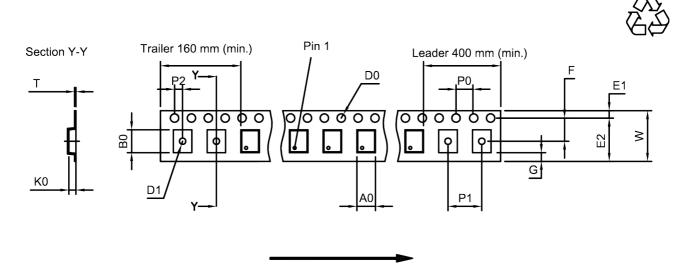


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10 Packing material

10.1 Tape



User direction of unreeling

Figure 6: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	3.25±0.1 mm	E ₂	10.25 mm (min.)	_	P ₁	4.0 _{±0.1} mm
B ₀	3.3±0.1 mm	F	5.5±0.05 mm	_	P_2	2.0 _{±0.1} mm
D_0	1.5+0.1/-0 mm	G	0.75 mm (min.)	_	Т	0.2±0.05 mm
D_1	1.5 mm (min.)	K ₀	1.5±0.1 mm		W	12.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	P ₀	4.0 _{±0.1} mm			

Table 1: Tape dimensions.



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10.2 Reel with diameter of 330 mm

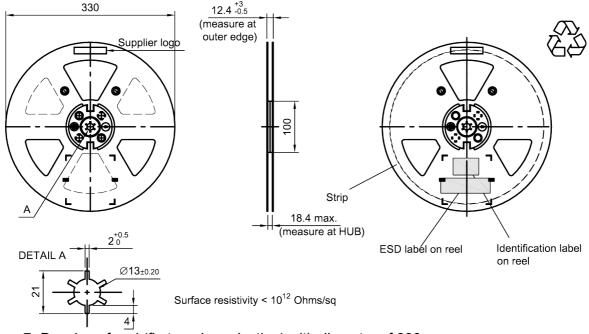


Figure 7: Drawing of reel (first-angle projection) with diameter of 330 mm.

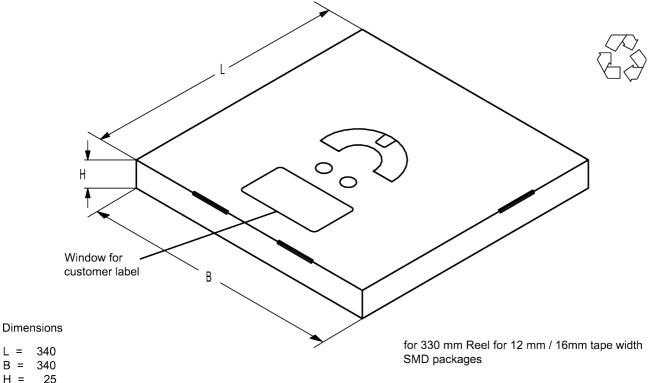


Figure 8: Drawing of folding box for reel with diameter of 330 mm.



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11 Marking

Products are marked with device designation, lot number, as well as production location and date code.

■ Device designation: The 4-character device designation of the ordering code is used for the marking.

Example for 4-character device designation: B3xxxxB1234xxxx

■ Lot number: The last 5 digits of the lot number are used for the marking.

Example: <u>12345</u>

■ Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

	1 st digit (day)					2 nd digit (year)			3 rd digit (month)				
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	Α	21	М	2010	Α	2022	Р	Jan	1	Jul	7
2	2	12	В	22	N	2011	В	2023	R	Feb	2	Aug	8
3	3	13	С	23	Р	2012	С	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	Т	Apr	4	Oct	0
5	5	15	E	25	S	2014	E	2026	U	May	5	Nov	N
6	6	16	F	26	Т	2015	F	2027	V	Jun	6	Dec	D
7	7	17	Н	27	U	2016	Н	2028	W				
8	8	18	J	28	V	2017	J	2029	Х				
9	9	19	K	29	W	2018	K	2030	Z				
10	0	20	L	30	Х	2019	L	2031	Α				
				31	Z	2020	М	2032	В				
						2021	N	and	so on				

Table 2: Production date code.

Example of how to decode production location and date code:

Code: C T F 6

Location: C \rightarrow Wuxi Day: T \rightarrow 26th Year: F \rightarrow 2015 Month: 6 \rightarrow June



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12 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

3 K/s 25 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
5 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
s to 70 s
n. 10 s
ax. 20 s
60 °C +0/-5 °C
0 °C +5/-0 °C for 10 s ± 1 s
3 K/s
easured at solder pads
3

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

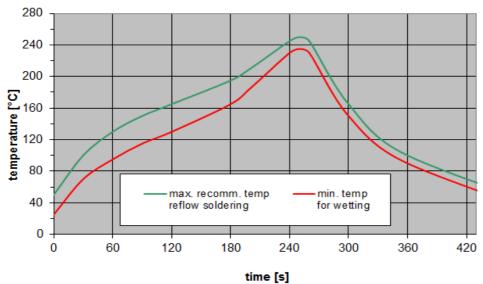


Figure 9: Recommended reflow profile for convection and infrared soldering – lead-free solder.



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13 ESD protection of SAW filters

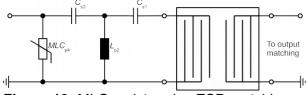
SAW filters are **E**lectro **S**tatic **D**ischarge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, "ESD matching" has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended "ESD matching" topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.



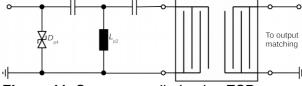


Figure 10: MLC varistor plus ESD matching.

Figure 11: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified "ESD matching" topologies can be used alternatively.

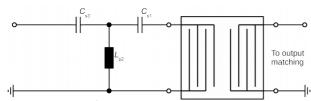


Figure 12: 3rd order high-pass structure for basic ESD protection.

In all three figures the shunt inductor $L_{\rm p2}$ could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to RF360 Application report: "**ESD protection for SAW filters**". This report can be found under www.rf360jv.com/rke. Click on "Applications Notes".



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14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.



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15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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